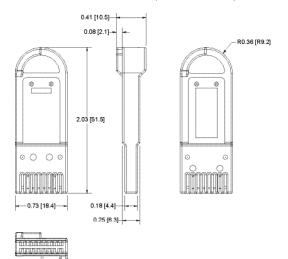
DFX-I Series Industrial RUGGEDrive™ Token with SD Card Functionality

Datakey DFX-I memory tokens deliver SD card functionality in a more robust and secure form factor than consumer and industrial SD cards. As part of the Industrial RUGGEDrive™ line, DFX-I tokens utilize SD memory that is rated for operation over the entire industrial temperature range of -40°C to +85°C. DFX-I models utilize 3D Triple-Level Cell (TLC) NAND flash, while DFX-IS models utilize more robust, pseudo Single-Level Cell (pSLC) NAND flash. Electrically, this token provides a standard SD interface (per the SD specification) – including support of SPI communications for embedded applications. DFX-I memory tokens utilize solid over-molded construction using ultra-rugged composites that protect the embedded memory from harsh environmental influences, such as dirt, moisture, chemicals and electrostatic discharge. The tokens can also be OEM-branded with a company logo, used in place of the Datakey logo.



For pin-out information, refer to the individual data sheets for the SR42xx (PCB-mount) and SR43xx or SR44xx (panel-mount) receptacles.



Drawing dimensions are in inches and millimeters [mm]. Dimensions are nominal and subject to manufacturer's tolerances.

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ATEK Access Technologies

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The power of memory, Secured,

MECHANICAL		
Contact Life	10,000 Insertion/Removal Cycles Min.	
Contact Arrangement	Fully Redundant (Front:Back)	
ELECTRICAL		
Power, Active ³	165 Milliwatts Typical at 3.3 V	
Power, Standby ³	6.6 Milliwatts Typical at 3.3 V	
Voltage	3.3 V Operation and Programming	
ESD Protection	15 kV (air), 10 kV (contact) Per IEC 61000-4-2	
ENVIRONMENTAL		
Storage Temperature	-40°C to + 85°C	
Operating Temperature	-40°C to + 85°C	
Relative Humidity	5% to 95% (non-condensing)	
Waterproof	Yes	
MEMORY ²		
Capacity Options (DFX-I) ²	16 GB, 32 GB, 64 GB	
Memory Type (DFX-I)	TLC NAND Flash	
Capacity Options (DFX-IS) ²	4 GB	
Memory Type (DFX-IS)	pSLC NAND Flash (TLC)	
EXTERNAL INTERFACE		
Interface	SD, SPI (per Secure Digital Specification)	
Transfer Rate (SD)	Speed Class 10, Minimum	
Clock Rate	Refer to SD Specification	
MATING COMPONENT(S)		
PCB-mount Receptacles	SR4210/SR4220/SR4230 – PCB/SM	
Panel-mount Receptacles	SR4210/SR4310/SR4410 Series	
	(including IP-rated versions)	
DFX PC Adapter (read/write)	607-0081-002A 607-0081-003A	
DFX PC Adapter (read-only)	007-0001-003A	
ORDERING INFORMATION DFX16GB-I		611-0225-01xA
DFX32GB-I		611-0226-01xA
DFX64GB-I		611-0227-01xA
DFX4GB-IS		611-0229-00xA
DFX-I Development Kit, 16 GB		702-0093-008A
DFX-I Development Kit, 32 GB		702-0093-009A
DFX-I Development Kit, 64 GB		702-0093-010A
DFX-IS Development Kit, 4 GB		702-0093-011A

1: "x" indicates optional color number.

"A" suffix on part number indicates RoHS compliance. See CE declaration below for details. Contact ATEK for additional memory capacity options.

NOTES

- Conforms with Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011, and as amended by Directive 2015/863/EU, on the restriction of the use of certain hazardous substances in electrical and electronic equipment.
- DFX-I token was tested for CE conformity while connected with a DFX PC Adapter. EN 55022 Class A Statement: Warning: This is a Class A product. In a domestic environment this product may cause radio interference in which

case the user may be required to take adequate measures.



Access the power of technology.